

Product Summary

B320A-B340A:								
V _{RRM} (V)	l _o (A)	V _{F(MAX)} @ 3A (V)	I _{R(MAX)} @ V _{RRM} (mA)					
20, 30, 40	3.0	0.50	0.5					

B350-B360A:

V _{RRM} (V)	I _O (A)	V _{F(typ)} @ +125°C (V)	I _{R(MAX)} @ V _{RRM} (mA)
50, 60	3.0	0.70	0.5

Description and Applications

For use in low-voltage, high-frequency inverters, freewheeling, DC-DC converters, and polarity protection applications.

Features

- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Notes 3 & 4)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic. "Green" Molding Compound. UL Flammability Classification 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte-Tin Finish). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band
- Weight: 0.064 grams (Approximate)

SMA





Bottom View

Ordering Information (Note 5)

Part Number*	Compliance	Case	Packaging
B3XXA-13-F	Standard	SMA	5,000/Tape & Reel

* XX = Device Type, e.g. B320A-13-F (SMA Package).

Marking Information (Note 6)



B3x0A = Product Type Marking Code, ex: B320A) | | = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 15 for 2015) WW = Week Code (01 to 53)

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
 - 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 - 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 - 4. Products manufactured with Date Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.
- 6. Device has a cathode band (as shown above) and may also have a cathode notch.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

Characteristic		Symbol	B320A	B330A	B340A	B350A	B360A	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	20	30	40	50	60	V
Average Rectified Output Current	@ T _T = +100°C	lo			3.0			А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load		I _{FSM}			80			А

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Total Power Dissipation - Steady State, TA = +25°C (Note 7)	PD	850	mW
Typical Thermal Resistance, Junction to Ambient (Note 7)	R _{0JA}	140	°C/W
Typical Thermal Resistance, Junction to Terminal (Note 8)	R _{θJT}	25	°C/W
Typical Thermal Resistance, Junction to Ambient (Note 8)	R _{θJA}	100	°C/W
Operating Temperature Range	TJ	-55 to +150	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

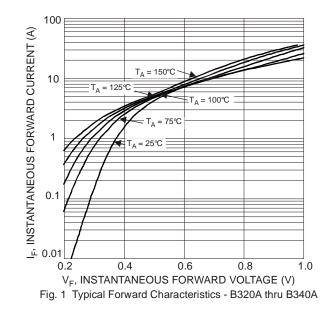
Characteristic		Symbol	Min	Тур	Max	Unit	Test Condition
Forward Valtage Drep	B320A, B330A, B340A	VF	—	—	0.50	V	I _F = 3.0A, T _A = +25°C
Forward Voltage Drop	B350A, B360A		_	—	0.70		
Leakage Current (Note 9)		I _R		—	0.5	س ۸	@ Rated V_R , $T_A = +25^{\circ}C$
			_	—	20	mA	@ Rated V _R , T _A = +100°C
Total Capacitance		Ст		200	_	pF	$V_R = 4V, f = 1MHz$

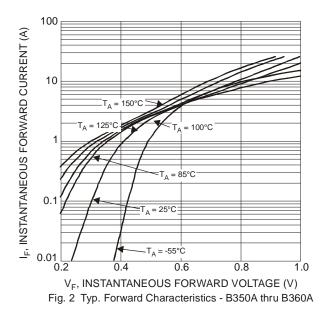
Notes:

7. Device mounted on FR-4 PCB, with minimum recommended pad layout.

8. Device mounted on glass epoxy substrate with 2x3mm copper pad.

9. Short duration pulse test used to minimize self-heating effect.

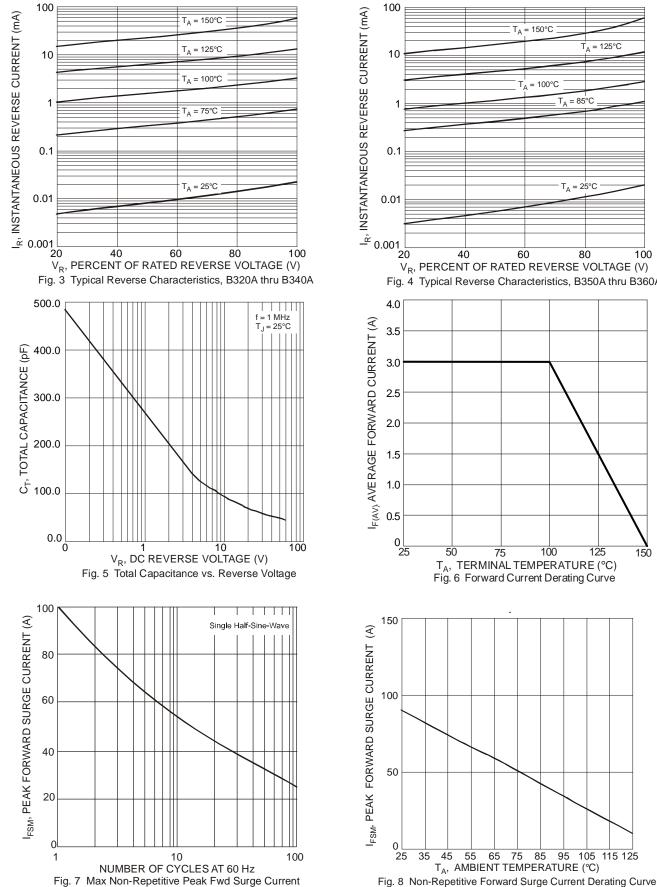


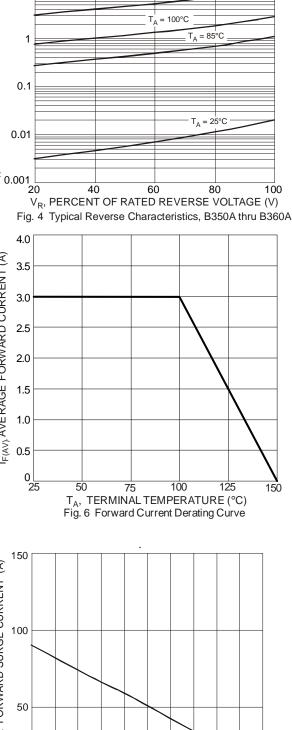




= 125°C

T_A = 150°C

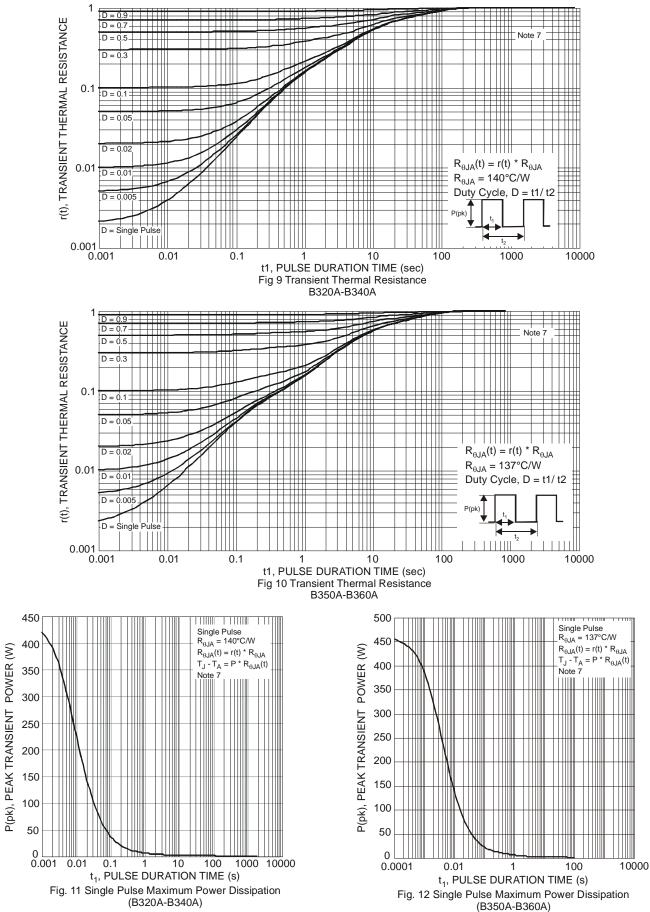




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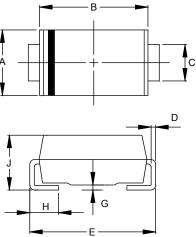


POWER (W)



Package Outline Dimensions

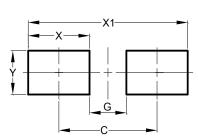
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SMA						
Dim	Min	Max				
Α	2.29	2.92				
В	4.00	4.60				
С	1.27	1.63				
D	0.15	0.31				
ш	4.80	5.59				
G	0.05	0.20				
Н	0.76	1.52				
J	1.96	2.40				
All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Y	1.70

SMA

SMA



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